



Rev. 1.3

UTRON

UT61L256

32K X 8 BIT HIGH SPEED LOW V_{CC} CMOS SRAM

FEATURES

- Fast access time : 8/10/12/15ns (max.)
- Low operating power consumption:
60 mA (typical.)
- Single 3.3V power supply
- All inputs and outputs are TTL compatible
- Fully static operation
- Three state outputs
- Package : 28-pin 300 mil SOJ
28-pin 8mm×13.4 mm STSOP

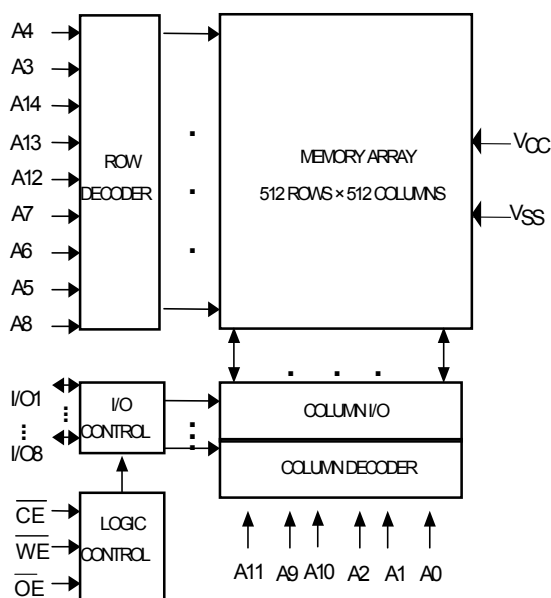
GENERAL DESCRIPTION

The UT61L256 is a 262,144-bit high speed CMOS static random access memory organized as 32,768 words by 8 bits. It is fabricated using high performance, high reliability CMOS technology.

The UT61L256 is designed for high-speed system application. It is particularly suited for use in high speed and high density system applications.

The UT61L256 operates from a signal 3.3V power supply and all inputs and outputs are fully TTL compatible

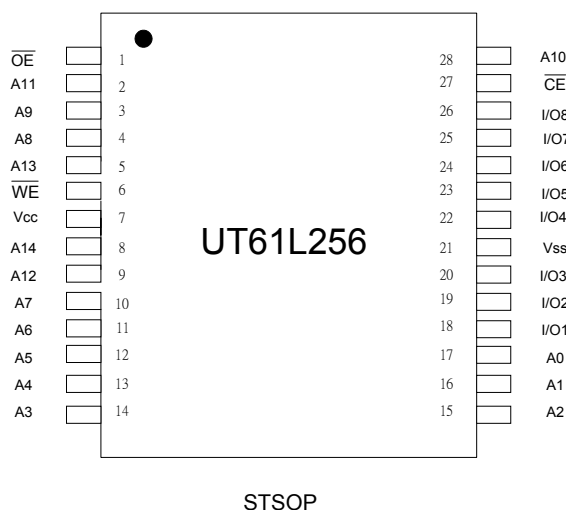
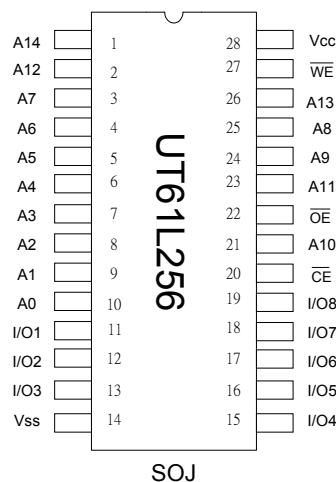
FUNCTIONAL BLOCK DIAGRAM



PIN DESCRIPTION

SYMBOL	DESCRIPTION
A0 - A14	Address Inputs
I/O1 - I/O8	Data Inputs/Outputs
$\overline{CE}$	Chip Enable Input
$\overline{WE}$	Write Enable Input
$\overline{OE}$	Output Enable Input
V _{CC}	Power Supply
V _{SS}	Ground

PIN CONFIGURATION





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PARAMETER	SYMBOL	RATING	UNIT
Terminal Voltage with Respect to V_{SS}	V_{TERM}	-0.5 to +4.5	V
Operating Temperature	T_A	0 to +70	°C
Storage Temperature	T_{STG}	-65 to +150	°C
Power Dissipation	P_D	1	W
DC Output Current	I_{OUT}	50	mA
Soldering Temperature (under 10 sec)	T_{solder}	260	°C

*Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to the absolute maximum rating conditions for extended period may affect device reliability.

TRUTH TABLE

MODE	$\overline{CE}$	$\overline{OE}$	$\overline{WE}$	I/O OPERATION	SUPPLY CURRENT
Standby	H	X	X	High - Z	I_{SB} , I_{SB1}
Output Disable	L	H	H	High - Z	I_{CC}
Read	L	L	H	D_{OUT}	I_{CC}
Write	L	X	L	D_{IN}	I_{CC}

Note: H = V_{IH} , L = V_{IL} , X = Don't care.

DC ELECTRICAL CHARACTERISTICS ($V_{CC} = 3.1V \sim 3.6V$, $T_A = 0^\circ C$ to $70^\circ C$)

PARAMETER	SYMBOL	TEST CONDITION		MIN.	MAX.	UNIT
Input High Voltage	V _{IH}			2.0	-	V
Input Low Voltage	V _{IL}			-	0.8	V
Input Leakage Current	I _{LI}	V _{SS} ≤V _{IN} ≤V _{CC}		- 1	1	μA
Output Leakage Current	I _{LO}	V _{SS} ≤V _{I/O} ≤V _{CC} CE =V _{IH} or OE =V _{IH} or WE = V _{IL}		- 1	1	μA
Output High Voltage	V _{OH}	I _{OH} = - 4mA		2.2	-	V
Output Low Voltage	V _{OL}	I _{OL} = 8mA		-	0.4	V
Operating Power Supply Current	I _{CC}	CE = V _{IL} , I _{I/O} = 0mA ,Cycle=Min.	- 8	-	90	mA
			- 10	-	75	mA
			- 12	-	60	mA
			- 15	-	50	mA
Standby Power Supply Current	I _{SB}	CE =V _{IH}		-	15	mA
	I _{SB1}	CE ≥ V _{CC} -0.2V		-	3	mA



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CAPACITANCE (TA=25°C, f=1.0MHz)

PARAMETER	SYMBOL	MIN.	MAX	UNIT
Input Capacitance	C _{IN}	-	8	pF
Input/Output Capacitance	C _{I/O}	-	10	pF

Note : These parameters are guaranteed by device characterization, but not production tested.

AC TEST CONDITIONS

Input Pulse Levels	0V to 3.0V
Input Rise and Fall Times	3ns
Input and Output Timing Reference Levels	1.5V
Output Load	C _L = 30pF, I _{OH} /I _{OL} = -4mA/8mA

AC ELECTRICAL CHARACTERISTICS (V_{CC} = 3.1V~3.6V, TA = 0°C to 70°C)**(1) READ CYCLE**

PARAMETER	SYMBOL	UT61L256 -8		UT61L256 -10		UT61L256 -12		UT61L256 -15		UNIT
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Read Cycle Time	t _{RC}	8	-	10	-	12	-	15	-	ns
Address Access Time	t _{AA}	-	8	-	10	-	12	-	15	ns
Chip Enable Access Time	t _{ACE}	-	8	-	10	-	12	-	15	ns
Output Enable Access Time	t _{OE}	-	3.2	-	5	-	6	-	7	ns
Chip Enable to Output in Low Z	t _{CLZ*}	1	-	2	-	3	-	4	-	ns
Output Enable to Output in Low Z	t _{OLZ*}	0	-	0	-	0	-	0	-	ns
Chip Disable to Output in High Z	t _{CHZ*}	-	4	-	5	-	6	-	7	ns
Output Disable to Output in High Z	t _{OHZ*}	-	4	-	5	-	6	-	7	ns
Output Hold from Address Change	t _{OH}	1	-	1	-	3	-	3	-	ns

(2) WRITE CYCLE

PARAMETER	SYMBOL	UT61L256 -8		UT61L256 -10		UT61L256 -12		UT61L256 -15		UNIT
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Write Cycle Time	t _{WC}	8	-	10	-	12	-	15	-	ns
Address Valid to End of Write	t _{AW}	6	-	8	-	12	-	15	-	ns
Chip Enable to End of Write	t _{CW}	6	-	8	-	12	-	15	-	ns
Address Set-up Time	t _{AS}	0	-	0	-	0	-	0	-	ns
Write Pulse Width	t _{WP}	5	-	8	-	9	-	10	-	ns
Write Recovery Time	t _{WR}	0	-	0	-	0	-	0	-	ns
Data to Write Time Overlap	t _{DW}	3.5	-	6	-	7	-	8	-	ns
Data Hold from End of Write Time	t _{DH}	0	-	0	-	0	-	0	-	ns
Output Active from End of Write	t _{OW*}	1	-	2	-	3	-	4	-	ns
Write to Output in High Z	t _{WHZ*}	-	3.5	-	6	-	7	-	8	ns

*These parameters are guaranteed by device characterization, but not production tested.



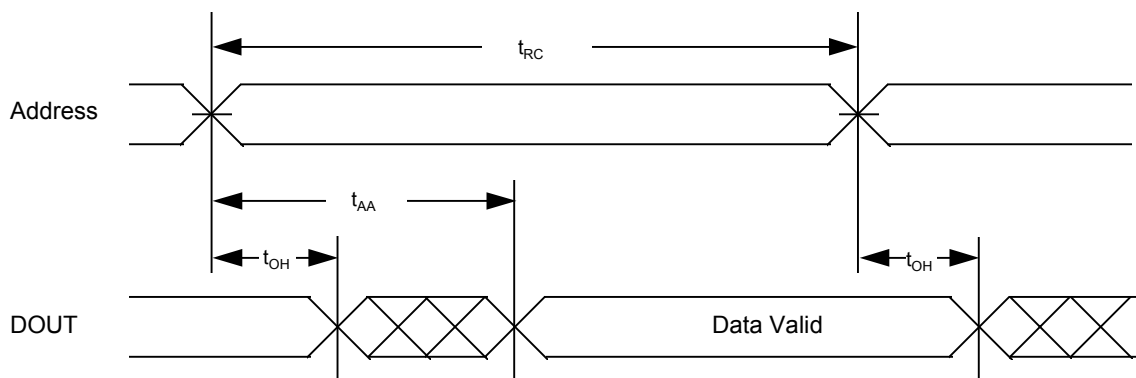
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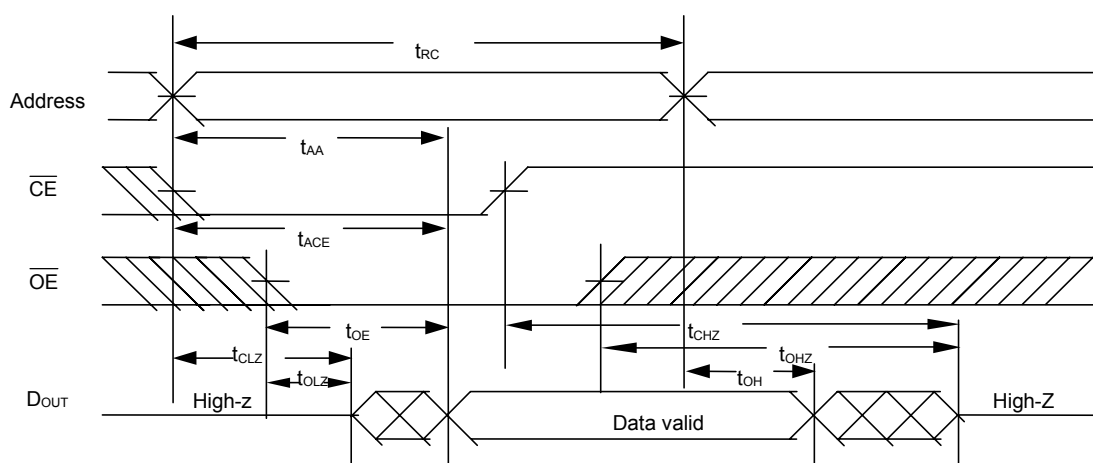
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TIMING WAVEFORMS

READ CYCLE 1 (Address Controlled) (1,2,4)



READ CYCLE 2 ($\overline{CE}$ and $\overline{OE}$ Controlled) (1,3,5,6)



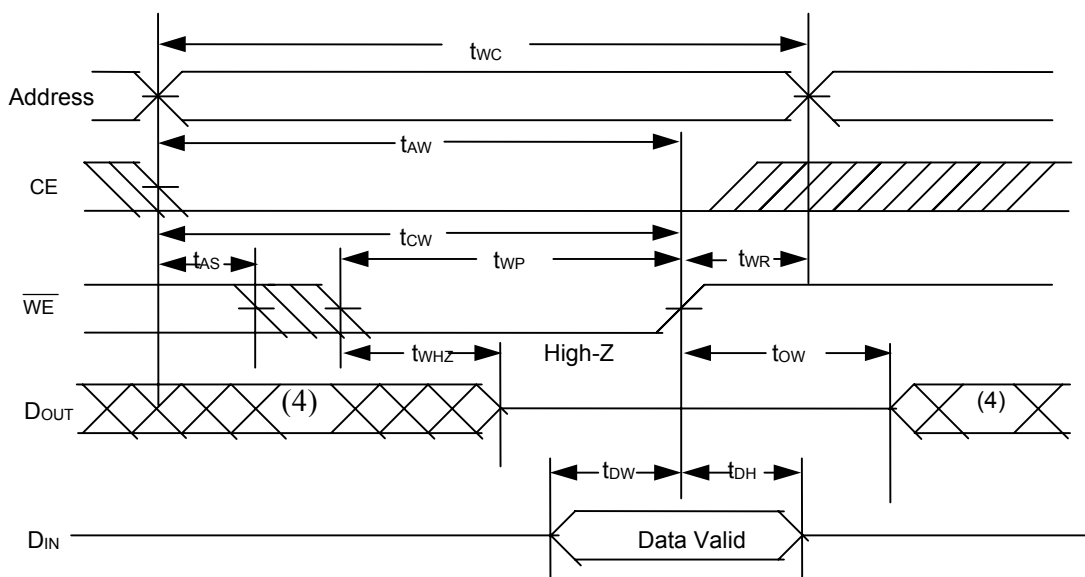
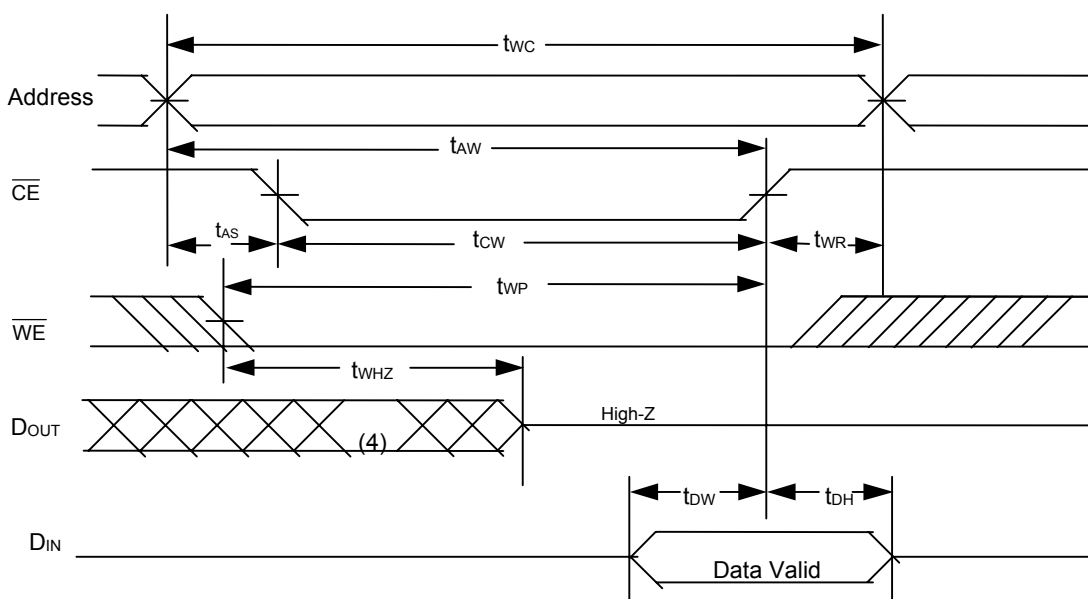
Notes :

1. $\overline{WE}$ is HIGH for read cycle.
2. Device is continuously selected $\overline{CE} = V_{IL}$.
3. Address must be valid prior to or coincident with $\overline{CE}$ transition; otherwise t_{AA} is the limiting parameter.
4. $\overline{OE}$ is LOW.
5. t_{CLZ} , t_{OLZ} , t_{CHZ} and t_{OHZ} are specified with $C_L = 5pF$. Transition is measured $\pm 500mV$ from steady state.
6. At any given temperature and voltage condition, t_{CHZ} is less than t_{CLZ} , t_{OHZ} is less than t_{OLZ} .



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32K X 8 BIT HIGH SPEED LOW V_{CC} CMOS SRAM**WRITE CYCLE 1 ($\overline{WE}$ Controlled) (1,2,3,5)****WRITE CYCLE 2 ($\overline{CE}$ Controlled) (1,2,5)**

Notes :

1. $\overline{WE}$ or $\overline{CE}$ must be HIGH during all address transitions.
2. A write occurs during the overlap of a low $\overline{CE}$ and a low $\overline{WE}$.
3. During a $\overline{WE}$ controlled with write cycle with $\overline{OE}$ LOW, t_{WP} must be greater than $t_{WHZ} + t_{DW}$ to allow the drivers to turn off and data to be placed on the bus.
4. During this period, I/O pins are in the output state, and input signals must not be applied.
5. If the $\overline{CE}$ LOW transition occurs simultaneously with or after $\overline{WE}$ LOW transition, the outputs remain in a high impedance state.
6. t_{OW} and t_{WHZ} are specified with $C_L = 5pF$. Transition is measured $\pm 500mV$ from steady state.



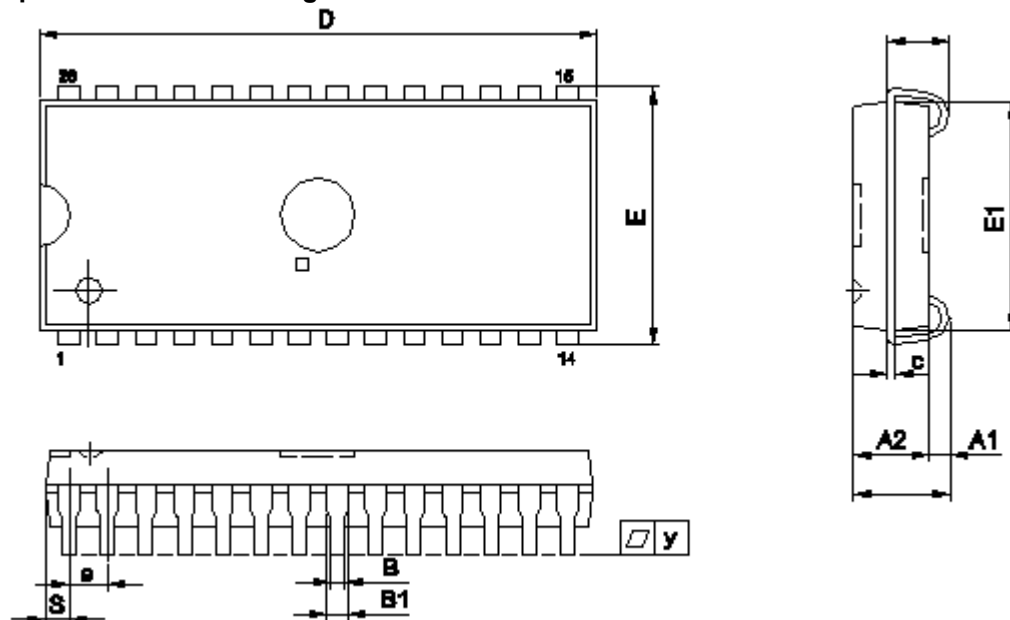
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PACKAGE OUTLINE DIMENSION

28pin 300 mil SOJ Package Outline Dimension



UNIT SYMBOL	INCH(REF)	MM(BASE)
A	0.148(MAX)	3.759(MAX)
A1	0.026(MIN)	0.66(MIN)
A2	0.100 ± 0.005	2.54 ± 0.127
B	0.018(TYP)	0.457(TYP)
B1	0.028(TYP)	0.711(TYP)
c	0.010(TYP)	0.254(TYP)
D	0.710(TYP)	18.034(TYP)
E	0.335(TYP)	8.509(TYP)
E1	0.3(TYP)	7.620(TYP)
e	0.050(TYP)	1.270(TYP)
L	0.087 ± 0.010	2.210 ± 0.254
S	0.030(TYP)	0.762(TYP)
y	0.003(MAX)	0.076(MAX)

NOTE

- 1.S/E/D DIM. NOT INCLUDING MOLD FLASH.
- 2.THE END FLASH IN PACKAGE LENGTHWISE IS NOT MORE THE 10 MILS EACH SIDE.

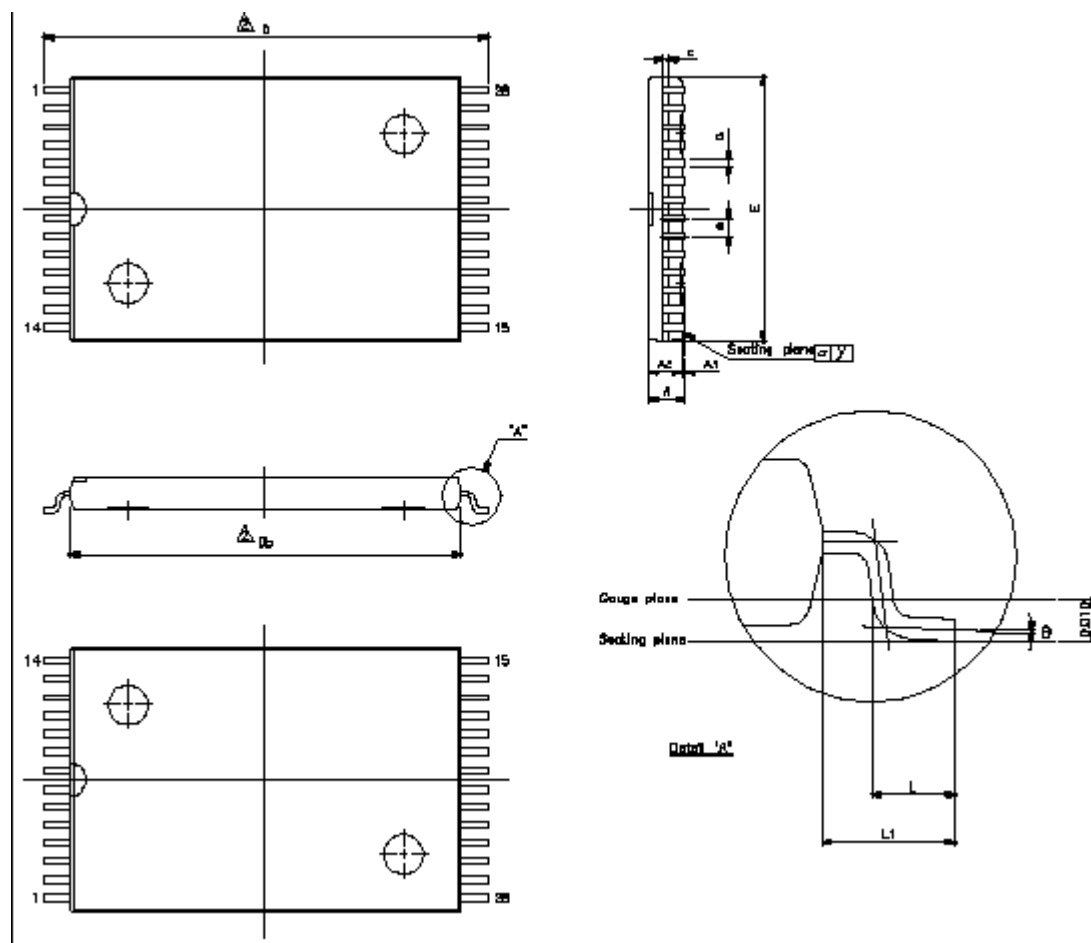


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28 pin 8×13.4mm STSOP Package Outline Dimension



Symbol	Unit	mm(ref.)	inch(base)
A		1.20(max.)	0.047(max.)
A1		0.10±0.05	0.004±0.002
A2		1.00±0.05	0.039±0.002
b		0.20(typ.)	0.008(typ.)
c		0.15(typ.)	0.006(typ.)
△ Db		11.80±0.10	0.465±0.004
E		8.00±0.10	0.315±0.004
e		0.55(typ.)	0.022(typ.)
△ D		13.40±0.20	0.528±0.008
△ L		0.50±0.10	0.020±0.004
△ L1		0.80±0.10	0.0315±0.004
△ y		0.08(max.)	0.003(max.)
θ		0°~5°	0°~5°

△ NOTE:

E dimension is not including end flash
The total of both sides' end flash is
not above 0.3mm.



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ORDERING INFORMATION

PART NO.	ACCESS TIME (ns)	PACKAGE
UT61L256JC-8	8	28 PIN SOJ
UT61L256JC-10	10	28 PIN SOJ
UT61L256JC-12	12	28 PIN SOJ
UT61L256JC-15	15	28 PIN SOJ
UT61L256LS-8	8	28 PIN STSOP
UT61L256LS-10	10	28 PIN STSOP
UT61L256LS-12	12	28 PIN STSOP
UT61L256LS-15	15	28 PIN STSOP



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REVISION HISTORY

REVISION	DESCRIPTION	DATE
REV. 1.0	Original.	
REV 1.1	Release version	Oct. 21,1999
REV 1.2		Oct ,2000
REV 1.3	1. The package name of TSOP-1 is revised as STSOP. 2. The symbols CE#,OE# and WE# are revised as $\overline{CE}$, $\overline{OE}$ and $\overline{WE}$	May 15,2001



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